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APPLICATION NO.	FI	LING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/630,544	44 07/29/2003		Tongbi Jiang	303.343US7	7498
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Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)				
	10/630,544	JIANG ET AL.				
Office Action Summary	Examiner	Art Unit				
	Brenda A. Lamb	1734				
The MAILING DATE of this communication ap Period for Reply	pears on the cover sheet	with the correspondence address				
A SHORTENED STATUTORY PERIOD FOR REPL WHICHEVER IS LONGER, FROM THE MAILING D. - Extensions of time may be available under the provisions of 37 CFR 1. after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period. - Failure to reply within the set or extended period for reply will, by statut Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	DATE OF THIS COMMUN 136(a). In no event, however, may I will apply and will expire SIX (6) M te, cause the application to become	NICATION. a reply be timely filed ONTHS from the mailing date of this communication. ABANDONED (35 U.S.C. § 133).				
Status						
1) Responsive to communication(s) filed on 2/2/	<u>2006</u> .					
2a) This action is FINAL . 2b) ☑ This	This action is FINAL . 2b)⊠ This action is non-final.					
	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
closed in accordance with the practice under	Ex parte Quayle, 1935 C	.D. 11, 453 O.G. 213.				
Disposition of Claims						
4) ⊠ Claim(s) 9-14 and 40-52 is/are pending in the 4a) Of the above claim(s) is/are withdra 5) □ Claim(s) is/are allowed. 6) ⊠ Claim(s) 9-14 and 40-52 is/are rejected. 7) □ Claim(s) is/are objected to. 8) □ Claim(s) are subject to restriction and/o	awn from consideration.					
Application Papers	·					
9) The specification is objected to by the Examine	er.					
10) The drawing(s) filed on is/are: a) acc	cepted or b) objected t	o by the Examiner.				
Applicant may not request that any objection to the	drawing(s) be held in abey	ance. See 37 CFR 1.85(a).				
Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the E	<u>. </u>					
Priority under 35 U.S.C. § 119						
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority documen 2. Certified copies of the priority documen 3. Copies of the certified copies of the priority documen application from the International Burea * See the attached detailed Office action for a list	nts have been received. Its have been received in prity documents have been au (PCT Rule 17.2(a)).	Application No en received in this National Stage				
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948)		v Summary (PTO-413) o(s)/Mail Date				
3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date		f Informal Patent Application (PTO-152)				

Application/Control Number: 10/630,544

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The nonstatutory double patenting rejection is based on a judicially created doctrine grounded in public policy (a policy reflected in the statute) so as to prevent the unjustified or improper timewise extension of the "right to exclude" granted by a patent and to prevent possible harassment by multiple assignees. See *In re Goodman*, 11 F.3d 1046, 29 USPQ2d 2010 (Fed. Cir. 1993); *In re Longi*, 759 F.2d 887, 225 USPQ 645 (Fed. Cir. 1985); *In re Van Ornum*, 686 F.2d 937, 214 USPQ 761 (CCPA 1982); *In re Vogel*, 422 F.2d 438, 164 USPQ 619 (CCPA 1970); and *In re Thorington*, 418 F.2d 528, 163 USPQ 644 (CCPA 1969).

A timely filed terminal disclaimer in compliance with 37 CFR 1.321(c) may be used to overcome an actual or provisional rejection based on a nonstatutory double patenting ground provided the conflicting application or patent is shown to be commonly owned with this application. See 37 CFR 1.130(b).

Effective January 1, 1994, a registered attorney or agent of record may sign a terminal disclaimer. A terminal disclaimer signed by the assignee must fully comply with 37 CFR 3.73(b).

Claims 9-12, 41 and 43 are provisionally rejected under the judicially created doctrine of obviousness-type double patenting as being unpatentable over claims 1-4 and 8-11 of copending Application No. 10/643,567 (Jiang et al). Although the conflicting claims are not identical, they are not patentably distinct from each other because Jiang et al 10/643,567 claims a semiconductor die stencil having a top surface, a bottom surface and one or more side surfaces, the bottom surface having a surface tension less than a surface tension of the top surface and less than a surface tension of the side surfaces. With respect to claims 10-12, the above cited application claims the first surface is a bottom surface and the second surface is a top surface. With respect to claims 41 and 43, Jiang et al 10/643,567 claims the bottom surface is a polymeric material.

Claims 46-49 are provisionally rejected on the ground of nonstatutory obviousness-type double patenting as being unpatentable over claims 1-4 and 8-11 of copending Application No. 10/643,567 (Jiang et al) in view of Hefele.

Jiang et al 10/643,567 are applied to reasons for the reasons and claims the sheet of material is impervious to the printable material but fails to claim the sheet of material is stainless steel. However, it would have been obvious to one having ordinary skill in the art at the time the invention was made to construct the sheet of material from stainless steel, since it has been held to be within the general skill of a worker in the art to select a known material on the basis of its suitability for the intended use as a matter of obvious design choice and, in any event, it is known to construct the base material of the stencil from stainless steel as taught by Hefele. In re Leshin, 125 USPQ 416. With respect to claim 47-48, the modified Jiang et al 10/643,567 inherently having a surface tension within the scope of the claims. Jiang et al 10/643,567 claims the coating is a polymeric material.

This is a <u>provisional</u> obviousness-type double patenting rejection.

Claims 9, 14, 40, 41, 44, 45 and 50-52 are provisionally rejected under the judicially created doctrine of obviousness-type double patenting as being unpatentable over claims 1-4 of copending Application No. 10/701,140. Although the conflicting claims are not identical, they are not patentably distinct from each other because Jiang et al claims a stencil having a top surface, a bottom surface and one or more side surfaces, the bottom surface having a surface tension less than a surface tension of the top surface and less than a surface tension of the side surfaces. With respect to claims 14, 40, 41, 44, 45 and 50-52, Jiang et al 10/701,140 claims the first surface is a bottom surface and the second surface is a top surface. Jiang et al 10/701,140 claims the second coating is a polymeric material and first coating is a surface is a coating

selected from the group consisting of any one or more of tungsten, tungsten carbide, tungsten nitride, nickel, and nickel alloy in any combination. Jiang et al 10/701,140 claims first coating is a surface is a coating selected from the group consisting of any one or more of tungsten, tungsten carbide, tungsten nitride, nickel, and nickel alloy in any combination which reads on the coating claimed by applicant thereby inherently providing the function of promoting the adhesive running onto the substrate. Jiang et al 10/701,140 stencil is capable of being used as a semiconductor die stencil since it teaches every element of the apparatus/stencil. Note it has been held that a recitation with respect to the manner in which a claimed apparatus is intended to be employed does not differentiate the claimed apparatus from a prior art apparatus satisfying the claimed structural limitations. Ex parte Masham, 2 USPQ 2d 1647 (1987). "[A]pparatus claims cover what a device is, not what a device does." Hewlett-Packard Co. v. Bausch & Lomb Inc., 909 F.2d 1464, 1469, 15 USPQ2d 1525, 1528 (Fed. Cir. 1990).

This is a <u>provisional</u> obviousness-type double patenting rejection because the conflicting claims have not in fact been patented.

Claims 9-14 and 40-52 are rejected under the judicially created doctrine of obviousness-type double patenting as being unpatentable over claims 1-46 of U.S. Patent No. 6,607,599 (Jiang et al). Although the conflicting claims are not identical, they are not patentably distinct from each other because Jiang et al claims a semiconductor die stencil to assist in application of a printable adhesive in a desired pattern onto a semiconductor die comprising: a sheet of material or stencil pattern, the sheet having a top surface and a bottom surface; a plurality of apertures in the sheet of

material defining a desired pattern for application of the printable adhesive; and a coating applied to the bottom surface of the sheet to retard spreading of the printable adhesive onto the bottom surface of the sheet. Jiang et al claims that the sheet of material is impervious to the adhesive and claims stencil or sheet of material is stainless steel. Jiang et al is silent to the coating being applied to the bottom of the sheet in a manner so as to obstruct of the flow of printable adhesive through the apertures onto the die and thereby reads on the claimed negative limitation of coating the sheet of material without obstruction of the adhesive through the apertures of the sheet. Jiang et al claims both the coating and the material have a surface tension, the surface tension of the coating being less than the surface tension of the material. Thus claims 9-12 and 46-47 are obvious over Jiang et al. With respect to claims 41, 43, 48-49, Jiang et al. claims the surface tension of the coating, a polymeric material – polytetrafluoroethylene. is at least an order of magnitude less than the surface tension of the material which is claimed as stainless steel. With respect to claim 13, Jiang et al claims the side surface of the stencil are coated with one material and the bottom surface of the stencil is coated with another different material such that surface tension of the bottom surface relative to the side surface is within the scope of the claim. With respect to claims 40 and 42, Jiang et al claims the top surface of the stencil is coated with a coating material within the scope of the claim. With respect to claim 14, 44, 45 and 50-52, Jiang et al. claims a semiconductor die stencil having a sheet of material or stencil pattern, the sheet having a top surface and a bottom surface, the first surface having a surface tension greater than a surface tension of the second surface to promote adhesive

running onto a semiconductor die; a plurality of apertures in the sheet of material defining a desired pattern for application of the printable adhesive. Jiang et al claims a semiconductor die stencil having a second surface is polymeric and first surface is coating within the scope of the claims

Claims 9-14 and 40-52 are rejected under the judicially created doctrine of obviousness-type double patenting as being unpatentable over claims 1-24 of U.S. Patent No. 6,641,669 (Jiang et al). Although the conflicting claims are not identical, they are not patentably distinct from each other because Jiang et al claims a stencil/screen/pattern to assist in application of a printable adhesive in a desired pattern onto a substrate comprising: a sheet of material or stencil pattern, the sheet or pattern having a top surface and a bottom surface; a plurality of apertures in the sheet of material defining a desired pattern for application of the printable adhesive; and a polymeric coating applied to the bottom surface of the sheet to retard spreading of the printable adhesive onto the bottom surface of the sheet. Jiang et al claims both the coating and the material have a surface tension, the surface tension of the coating being less than the surface tension of the material such as set forth in claims 9-12, 41, 43, 46-47 and 49. Jiang et al fails to claim that the sheet of material is impervious to the adhesive but the claimed stencil or sheet of material which is stainless steel is impervious to adhesive. Jiang et al is silent to the coating being applied to the bottom of the sheet in a manner so as to obstruct of the flow of printable adhesive through the apertures onto the die and thereby reads on the claimed negative limitation of coating the sheet of material without obstruction of the adhesive through the apertures of the

sheet. Further with respect to claim 14, 40, 42, 44-45 and 50-52, Jiang et al claims the stencil is further comprised of a layer to promote spreading of the printable material and the layer is selected from the group consisting of one of tungsten, tungsten carbide, tungsten nitride. Jiang et al is capable of its end use as a semiconductor stencil since it claims every structural element of the claimed stencil. With respect to claim 48, Jiang et al claims the surface tension of the coating which is claimed as being polytetrafluoroethylene is at least an order of magnitude less than the surface tension of the material which is claimed as stainless steel.

Claims 9-14 and 40-52 are rejected under the judicially created doctrine of obviousness-type double patenting as being unpatentable over claims 1-77 of U.S. Patent No. 6,669,781 (Jiang et al). Although the conflicting claims are not identical, they are not patentably distinct from each other because Jiang et al claims a stencil/screen/pattern to assist in application of a printable adhesive in a desired pattern onto a substrate comprising: a sheet of material or stencil pattern, the sheet or pattern having a top surface and a bottom surface; a plurality of apertures in the sheet of material defining a desired pattern for application of the printable adhesive; and a polymeric coating applied to the bottom surface of the sheet to retard spreading of the printable adhesive onto the bottom surface of the sheet. Jiang et al claims both the coating and the material have a surface tension, the surface tension of the coating being less than the surface tension of the material such as set forth in claims 9-12, 41, 43, 46-47 and 49. Jiang et al fails to claim that the sheet of material is impervious to the adhesive but the claimed stencil or sheet of material which is stainless steel is

impervious to adhesive. Jiang et al is silent to the coating being applied to the bottom of the sheet in a manner so as to obstruct of the flow of printable adhesive through the apertures onto the die and thereby reads on the claimed negative limitation of coating the sheet of material without obstruction of the adhesive through the apertures of the sheet. Further with respect to claim 13-14, 40, 42, 44-45 and 50-52, Jiang et al claims the stencil is further comprised of a coating layer to promote spreading of the printable material applied to the top surface and side walls of the sheet of material and the layer is selected from the group consisting of one of tungsten, tungsten carbide, tungsten nitride. Jiang et al is capable of its end use as a semiconductor stencil as set forth in claims 9-14, 40-47 and 49-52 since it claims every structural element of the claimed stencil. With respect to claim 48, Jiang et al claims the surface tension of the coating which is claimed as being polytetrafluoroethylene is at least an order of magnitude less than the surface tension of the material which is claimed as stainless steel.

Claims 9-13 and 40-52 are rejected under the judicially created doctrine of obviousness-type double patenting as being unpatentable over claims 1-24 of U.S. Patent No. 6,599,365 (Jiang et al). Although the conflicting claims are not identical, they are not patentably distinct from each other because Jiang et al claims a semiconductor stencil/screen/pattern to assist in application of a printable adhesive in a desired pattern onto a substrate comprising: a sheet of material or stencil pattern, the sheet or pattern having a top surface and a bottom surface; a plurality of apertures in the sheet of material defining a desired pattern for application of the printable adhesive; and a polymeric coating applied to the bottom surface of the sheet to retard spreading

of the printable adhesive onto the bottom surface of the sheet. Jiang et al claims both the coating and the material have a surface tension, the surface tension of the coating being less than the surface tension of the material such as set forth in claims 9-12, 41, 43, 46-47 and 49. Jiang et al fails to claim that the sheet of material is impervious to the adhesive but the claimed stencil or sheet of material which is stainless steel is impervious to adhesive. Jiang et al is silent to the coating being applied to the bottom of the sheet in a manner so as to obstruct of the flow of printable adhesive through the apertures onto the die and thereby reads on the claimed negative limitation of coating the sheet of material without obstruction of the adhesive through the apertures of the sheet. Further with respect to claim 13-14, 40, 42, 44-45 and 50-52, Jiang et al claims the stencil is further comprised of a coating layer to promote spreading of the printable material applied to the top surface and side walls of the sheet of material and the layer is selected from the group consisting of one of tungsten, tungsten carbide, tungsten nitride. Jiang et al is capable of its end use as a semiconductor stencil as set forth in claims 9-14, 40-47 and 49-52 since it claims every structural element of the claimed stencil. With respect to claim 48, Jiang et al claims the surface tension of the polymeric coating is known to exhibit a surface tension having at least an order of magnitude less than the surface tension of the material which is claimed as stainless steel as disclosed by applicant in the specification.

The following is a quotation of the first paragraph of 35 U.S.C. 112:

The specification shall contain a written description of the invention, and of the manner and process of making and using it, in such full, clear, concise, and exact terms as to enable any person skilled in the art to which it pertains, or with which it is most nearly connected, to make and use the same and shall set forth the best mode contemplated by the inventor of carrying out his invention.

Claims 46-49 are rejected under 35 U.S.C. 112, first paragraph, as failing to comply with the written description requirement. The claim(s) contains subject matter which was not described in the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention.

The originally filed specification fails to teach a coating applied to **at least** one top or one bottom surface of the sheet to retard spreading of the printable adhesive onto the at least one top or one bottom surface of the sheet without obstruction of the flow of printable adhesive through the apertures.

The recitation that a coating to retard spreading of the printable adhesive is applied to at least one top or one bottom surface of the sheet without obstruction of the flow of printable adhesive through the apertures broadly reads with the term "comprising" on the coating being applied to all the surfaces of the sheet which is not disclosed by the originally filed specification. Further, the recitation that a coating to retard spreading of the printable adhesive is applied to at least one top or one bottom surface of the sheet without obstruction of the flow of printable adhesive through the apertures narrowly reads on the coating to retard spreading of the printable adhesive being applied only the top surface, surface described by applicant in the specification as the surface over which the printable adhesive is desirably spread, which is not disclosed by the originally filed specification.

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

Claims 9, 14, 40, 45, 50-52 are rejected under 35 U.S.C. 102(b) as being anticipated by Pollack.

Pollack teaches an apparatus/device which is a perforated sheet of material having a top surface and bottom surface and one or more side surfaces. Pollack teaches the bottom surface of the perforated sheet is comprised of layer of plated nickel which formed over copper substrate. The bottom surface of the Pollack apparatus/device which is copper has a surface tension which is known to be less than a surface tension of the top surface and side surfaces formed within the apertures of the

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nickel plating layer. Pollack apparatus/device is capable of the end use as a stencil since it has the structure required for a stencil, that is, an impervious sheet of material perforated with a pattern of openings through which a material can be forced. The recitation of the intended end use of perforated sheet coated on bottom side with the layer of nickel plating as a semiconductor die stencil does not structurally further limit the claimed device/apparatus over the above recited combination of references since Pollack teaches each of the structural elements of the claimed apparatus/device. Note it has been held that a recitation with respect to the manner in which a claimed apparatus is intended to be employed does not differentiate the claimed apparatus from a prior art apparatus satisfying the claimed structural limitations. Ex parte Masham, 2 USPQ 2d 1647 (1987). "[A]pparatus claims cover what a device is, not what a device does." Hewlett-Packard Co. v. Bausch & Lomb Inc., 909 F.2d 1464, 1469, 15 USPQ2d 1525, 1528 (Fed. Cir. 1990). Thus Pollack teaches each of the structural elements of the apparatus/device as set forth in claims 9 and 40. With respect to claims 14, 45 and 50-52, Pollack teaches a stencil having at least a first surface and a second surface. The Pollack's first surface is comprised of nickel plating layer which is within the scope of the material disclosed and claimed by applicant thereby the nickel plating layer inherently providing the function of promoting adhesive running onto a semiconductor die. Pollack's first surface of nickel plating has a surface tension which is greater than the known surface tension of the second surface of the stencil which is copper. Thus Pollack teaches each of the structural elements of the apparatus/device as set forth in claims 14, 45 and 50-52.

Claims 9-13, 41, 43 and 46-49 are rejected under 35 U.S.C. 103(a) as being unpatentable over Dreyfus in view of Cahne 3,008,601.

Dreyfus teaches an apparatus/device which is a perforated sheet of material having a top surface and bottom surface and one or more side surfaces. Dreyfus apparatus/device is capable of the end use as a stencil since it has the structure required for a stencil, that is, an impervious sheet of material perforated with a pattern of openings through which a material can be forced. Dreyfus teaches the material of construction of the perforated sheet includes a wide variety of metal materials including stainless steel, aluminum and the like. Dreyfus fails to teach the surface tension of one surface, bottom surface, is less than the surface tension of other surfaces, top surface and the side surfaces. However, Cahne teaches an apparatus/device which is comprised of a sheet of metal material having a polymer coating applied only on one surface. Cahne teaches providing a coating of polytetrafluoroethylene on the sheet of metal material which is identical to the coating disclosed by applicant thereby inherently providing the claimed property of retarding the spread of printable adhesive. Cahne fails to teach the sheet of material is perforated so to act as a stencil. However, it would have been obvious to modify the Dreyfus perforated sheet of metal material, stainless steel or aluminum, to provide a coating only on one side since Cahne teaches providing a coating of polytetrafluoroethylene on a metal material for used in high temperature environments, aluminum, and provide the coating disclosed by applicant only on one side of the sheet of material such as a bottom or lower side 12 as shown in Figure 5 to prevent sticking of material being treated to the recited surface with the surface tension

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of the coated surface being less than the surface tension of other surfaces, top surface and the side surfaces. The recitation of the intended end use of perforated sheet coated on one side with the coating of a polymeric material, polytetrafluoroethylene, as a semiconductor die stencil does not structurally further limit the claimed device/apparatus over the above recited combination of references since Dreyfus in view of Cahne and Johnson teaches each of the structural elements of the claimed apparatus/device. Note it has been held that a recitation with respect to the manner in which a claimed apparatus is intended to be employed does not differentiate the claimed apparatus from a prior art apparatus satisfying the claimed structural limitations. Ex parte Masham, 2 USPQ 2d 1647 (1987). "[A]pparatus claims cover what a device is, not what a device does." Hewlett-Packard Co. v. Bausch & Lomb Inc., 909 F.2d 1464, 1469, 15 USPQ2d 1525, 1528 (Fed. Cir. 1990). Thus claims 9-13, 41 and 43 are obvious over the above recited references. With respect to claims 46-49, the same rejection applied to claims 9-13, 41 and 43. Cahne fails to teach the coating of polytetrafluoroethylene is provided on stainless sheet. However, it would have been obvious given the modified Dreyfus perforated sheet of metal material with the Cahne polymeric coating applied onto at least one side of the sheet of material, at least one top or bottom surface, to construct the perforated sheet of material from another known material use in such high temperature environments such as stainless steel for the known advantages of stainless steel which include high corrosion resistance.

Claims 9-14 and 40-45 are rejected under 35 U.S.C. 102(b) as being anticipated by Caincross et al 5,447,757.

Caincross et al teaches a stencil/device/apparatus as disclosed in Example 3 which is comprised of the following elements: a top surface, a bottom surface, and one or more side surfaces. Caincross et al bottom surface having a surface tension defined by the polymeric edge and the surface tension of the polymeric edge is less than a surface tension of the top surface and less than a surface tension of the side surfaces defined in part by the silver screen which can be plated using a variety of material including nickel (see column 7 lines 39-45). Cairncross et al stencil is capable of being used as a semiconductor die stencil since Cairncross et al teaches each of the structural elements of the claimed stencil/device/apparatus. Note it has been held that a recitation with respect to the manner in which a claimed apparatus is intended to be employed does not differentiate the claimed apparatus from a prior art apparatus satisfying the claimed structural limitations. Ex parte Masham, 2 USPQ 2d 1647 (1987). "[A]pparatus claims cover what a device is, not what a device does." Hewlett-Packard Co. v. Bausch & Lomb Inc., 909 F.2d 1464, 1469, 15 USPQ2d 1525, 1528 (Fed. Cir. 1990). Thus every element of the stencil/device/apparatus is taught by Caincross et al. With respect to claims 40-41, Cairncross et al teaches a top surface within scope of claim 40 (nickel coating on the silver screen) and bottom surface which is a polymeric material. With respect to claim 14, Cairncross et al teaches the first surface having a nickel coating which is within the scope of the material claimed by applicant thereby inherently providing the function of promoting the flow of adhesive onto the substrate. With respect to claims 44-45, the same rejection applied to claims 40-41 is applied here. With respect to claim 10-13, the same rejection applied to claim 9 is applied here. The

surface tension of the polymeric ledge on the Cairncross et al is less than the nickel top surface of the nickel plated silver screen thereby retarding flow of adhesive relative to the flow of adhesive on the nickel surface of the nickel plated silver screen. Note the screen has a thickness so as to provide side walls coated with a plated layer of nickel. With respect to claims 42-43, the same rejection applied to claims 40-41 is applied here.

Claims 46-49 are rejected under 35 U.S.C. 103(a) as being unpatentable over Japan 59-76868 in view of Hefele.

Japan '868 teaches a die stencil to assist in application of a printable material in a desired pattern onto a substrate comprising: a sheet of metal material which is impervious to a printable material or adhesive applied thereto; a plurality of apertures in the sheet of material defining a desired pattern for application of the printable material: and a coating applied to surfaces of the sheet of material including bottom surface of the sheet to retard spreading of the printable material onto surfaces of the stencil including the bottom surface of the sheet. Japan '868 is silent as to the obstruction of the flow of printable material through the apertures and thereby reads on the negative limitation that the material flows without obstruction of the flow of printable material through the apertures. Japan '868 teaches the coating is a polymeric material which within the scope of claims 8 and 11, specifically tetrafluoroethylene which is identical to that disclosed applicant at page 9 lines 12-22, and the material of construction of the sheet of material is within scope of that disclosed by applicant at page 9 lines 6-11 and thereby inherently reads on the claimed limitations of the coating and the sheet of metal material (surface tension properties) such as set forth in claims 46-49. Japan '868

teaches the sheet of material is comprised of metal but fails to teach that sheet of material is constructed from stainless steel. However, it would have been obvious to one having ordinary skill in the art at the time the invention was made to construct the stencil base 1 from stainless steel since it has been held to be within the general skill of a worker in the art to select a known material on the basis of its suitability for the intended use as a matter of obvious design choice and especially since Hefele teaches the use of a stainless steel as the stencil base 1 for a coated pattern stencil for the obvious advantage of stainless steel- good corrosion resistance. In re Leshin, 125 USPQ 416. Japan '868 is capable of the end use of being aligned above the semiconductor die and capable of the end use of assisting in the application of a printable material or a printable adhesive material in a desired pattern onto a semiconductor die since it teaches every claimed element of the apparatus/die stencil as set forth in claims 46-49.

Claims 46-49 are rejected under 35 U.S.C. 102(b) as being anticipated by Pryor et al.

Pryor et al teaches a die stencil to assist in application of a printable material in a desired pattern onto a substrate comprising: a sheet of aluminum material which is impervious to a printable material applied thereto; a plurality of apertures in the sheet of material defining a desired pattern for application of the printable material; and a coating applied to at least one top or one bottom surface of the sheet to retard spreading of the printable material onto the at least one top or one bottom surface of the sheet. Pryor et al is silent as to the obstruction of the flow of printable material through the apertures

and thereby reads negative limitation that the material flows without obstruction of the flow of printable material through the apertures. Pryor et al teaches the coating is a polymeric material which within the scope of claim 49, specifically tetrafluoroethylene which is identical to that disclosed applicant at page 9 lines 12-22, and the material of construction of the sheet of material is within scope of that disclosed by applicant at page 9 lines 6-11 and thereby inherently reads on the claimed limitations of the coating and the sheet of metal material (surface tension properties) such as set forth in claims 2-3 and 9-10. Pryor et al teaches the sheet of material is comprised of metal but fails to teach that sheet of material is constructed from stainless steel. However, it would have been obvious to one having ordinary skill in the art at the time the invention was made to construct the stencil base 1 from stainless steel since it has been held to be within the general skill of a worker in the art to select a known material on the basis of its suitability for the intended use as a matter of obvious design choice. In re Leshin, 125 USPQ 416. Pryor et al is capable of the end use of being aligned above the semiconductor die and assisting in the application of a printable material or a printable adhesive material in a desired pattern onto a semiconductor die since it teaches every claimed element of the apparatus/die stencil set forth in claims 46-49.

Applicant's arguments with respect to claims have been considered but are moot in view of the new ground(s) of rejection.

Apllicant's argument that Japan '868 does not show or suggest the use of the mask with a "printable adhesive" as required in claims 46-49 is found to be non-persuasive. As discussed above, the modified Japan '868 apparatus is comprised of a

stainless sheet coated on at least one top or one bottom surface of the sheet with a layer of coating material, the coated sheet having a plurality of apertures defining a desired pattern for application of the printable material. The coating layer of modified Japan '868 apparatus is polytetrafluoroethylene which is identical to the coating disclosed by applicant page 8 line 25 to page 6 line 6 thereby inherently providing the same function claimed by applicant that is retard the spread adhesive on the claimed surface of the stencil.

Applicant's argument that Japan '868 teaches the stencil has two distinct layers of coating rather than single layer of coating is found to be non-persuasive since it is not commensurate in scope with claim language with the claim open with the term "comprising" to the claimed apparatus having multiple layers of coating.

Applicant's argument of the lack of motivation for combining Japan '868 and Hefele is found to be non-persuasive. In response to applicant's argument that there is no suggestion to combine the references, the examiner recognizes that obviousness can only be established by combining or modifying the teachings of the prior art to produce the claimed invention where there is some teaching, suggestion, or motivation to do so found either in the references themselves or in the knowledge generally available to one of ordinary skill in the art. See *In re Fine*, 837 F.2d 1071, 5

USPQ2d 1596 (Fed. Cir. 1988)and *In re Jones*, 958 F.2d 347, 21 USPQ2d 1941 (Fed. Cir. 1992). In this case, Japan '868 teaches the base for the coated stencil is a metal sheet but fails to teach the type of metal. However, Hefele is applied to teach constructing a coated stencil wherein the perforated base is stainless steel (see column

2 lines 49-52). Therefore, it would have been obvious to one skilled in the art to chose stainless steel as the type of metal material in the Japan '868 perforated base sheet since Hefele teaches that stainless steel is the preferred material of construction for coated stencil for the obvious advantage of stainless steel-good corrosion resistance.

Applicant's argument at page 10 of the instant amendment that "the coating "to retard spreading" of claim 46 is not the high surface tension Teflon of Pryor et al but is a coating having a surface lower than that of the base material" is not understood. In contrast to applicant's arguments, the originally filed specification indicates at page 8 line 25 to page 9 line 6 indicates that the coating applied to the patterned base to retard spreading of the adhesive material is polytetrafluororethylene and Pryor et al teaches a stencil coated with TEFLON or polytetrafluororethylene so as to provide a polytetrafluororethylene in contact with coating and unclear how applicant's polytetrafluoroethylene surface differs from Pryor et al's TEFLON or polytetrafluororethylene so as to provide a lower surface tension than that of Pryor et al.

Any inquiry concerning this communication should be directed to Brenda A. Lamb at telephone number (571) 272-1231. The examiner can normally be reached on Monday-Tuesday and Thursday-Friday with alternate Wednesdays off.

renda abele Lamb

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Examiner

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